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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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DOCUMENT : TBL1608245M2

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TBL-1608-245-M2 THIN FILM BALUN

- 1. Feature
 - 1-1 2.45GHz Thin Film Balun.
 - 1-2 For ISM Band applications like Bluetooth/WLAN.
 - 1-3 Lead Free, RoHS compliance
- 2. Part Number

$$TBL - 1608 - 245 - M2 - XX$$

- (1)
- (2)
- (3)
- (4)
- (5)

Where

- (1) TBL: Thin Film Balun
- (2) Size:

4 digits of number $-1608 = 1.60 \times 0.8 \text{ mm}$

(3) Center Frequency:

$$245 = 2.45 \text{ GHz}$$

(4) Type

Refer to Table 3-1

(5) XX

Internal Code

3. Ratings

3-1 Specifications

Part Number	TBL-1608-245-M2
Unbalance Port Impedance	50Ω
Balance Port Impedance	100Ω
Nominal Center Frequency	2450MHz
Bandwidth	2400 ~ 2500MHz
Phase Balance	180 ±10°
Amplitude Balance	0 ±1.0dB max
Insertion Loss	1.0 dB Max. at $+25^{\circ}$ C
VSWR at Unbalance Port in BW	2.0 Max.
Power Capacity	500mW Max.

3-2 Operation Temperature: -40° C to $+85^{\circ}$ C

3-3 Storage Temperature: $+15^{\circ}$ C to $+35^{\circ}$ C

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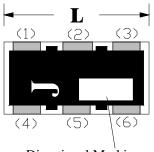
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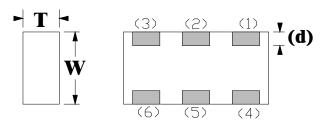
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4. Outline Dimension

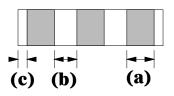
TopView







Directional Marking



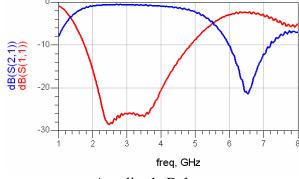
Code	Dimension(mm)	Code	Dimension(mm)
L	1.6±0.1	(a)	0.3±0.1
w	0.8±0.2	(b)	0.25±0.1
T	0.4±0.1	(c)	0.1±0.1
		(d)	0.2±0.1

Terminal Configuration

(1)	GND
(2)	NC
(3)	Unbalance Port
(4)	Balance Port
(5)	NC
(6)	Balance Port

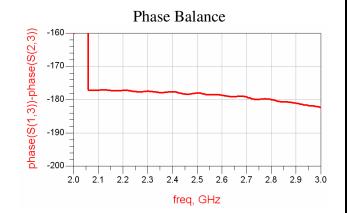
5. Electrical Performance

Insertion Loss and Return Loss



Amplitude Balance

(E'1)889 -2 -4 -2.0 2.1 2.2 2.3 2.4 2.5 2.6 2.7 2.8 2.9 3.0 freq, GHz

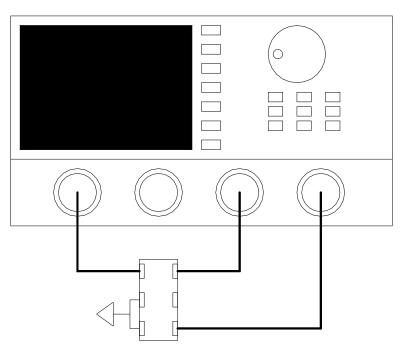


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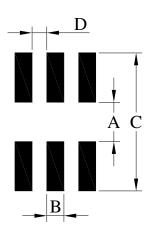
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6. Measurement



Network analyzer: Agilent PNA N5230A

7. Recommended Land Pattern



A	0.3
В	0.25
С	1.4
D	0.25

Unit: mm

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8. Reliability Test

8-1 Electrical

Item	Specification and Requirement	Test Method
Temperature	Satisfy electrical characteristics	Solder the sample on PCB.
Characteristics		Exposure at each temperature,
		-40°C, -20°C, 0°C, +25°C, +50°C, +85°C
		for 30minutes

8-2 Mechanical

Item	Specification and Requirement	Test Method
Itelli	1	Test Method
Solderability	The Surface of terminal immersed	Solder bath :
	shall be minimum of 95% covered	After immersing in flux, dip in $245 \pm 5^{\circ}$ C
	with a new coating of solder	molten solder bath for 2 ± 0.5 seconds
Resistance to solder	Satisfy electrical characteristics	(1) Pre-heat : $100 \sim 110^{\circ}$ C for 30
Heat	without distinct deformation in	seconds
	appearance	(2) Immersed at solder bath of $270 \pm 5^{\circ}$ C
		for 20 ± 1 seconds
Vibration	Satisfy electrical characteristics	Vibrate as apply 20 to 2,000Hz, 186m/s ²
	without Mechanical damage such as	(19G) acceleration 1.5mm amplitude for 2
	break	hours in each of three (X, Y, Z) axis (total 6
		hours).
Shock	Satisfy electrical characteristics	(1) Break value: 490 N
	without mechanical damaged such as	(2) Duration of pulse : 11ms
	break	(3) 3 times in each positive and negative
		direction of 3 mutual perpendicular
		directions.
Bending Test	Satisfy electrical characteristics	Bending value : 3mm for
	without mechanical damage such as	30 ± 1 seconds
	break	
Solvent Resistant	Marking should be legible without	(1) Solvent: Trichloroethane or Isopropyl
	mechanical and distinct damage in	alcohol.
	appearance	(2) Immersed in solvent at room temperature
		for 90 seconds
Drop Test	Satisfy electrical characteristics	Drop the sample from a height of 1m to
	without mechanical damage	concrete ground for 10 times

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8-3 Load Life

Item	Specification and Requirement	Test Method
Rapid change of	Satisfy Electrical Characteristics.	Perform 5 cycles as follows:
temperature	Without distinct damage.	-55° C for 30minutes \rightarrow room temperature
		for 3 minutes→
		+125°C for 30minutes → room temperature
		for 3 minutes.
		(Dwell time : 5 to 8 minutes)
Humidity Resistance	Satisfy Electrical Characteristics.	Precondition at +25°C for 1hour.
Test	Without distinct damage.	Let stand at temperature $+40 \pm 3^{\circ}\text{C}$, $90 \sim 95\%$
		relative humidity for 1,000 hours before
		taking final measurements.
Low Temperature Store	Satisfy Electrical Characteristics.	Solder the sample on PCB.
	Without distinct damage.	Exposure at $-55 \pm 3^{\circ}$ C for 1,000 hours.
		1~2 hours exposure at room temperature and
		humidity, prior to measurement.
High Temperature Store	Satisfy Electrical Characteristics.	Solder the sample on PCB.
	Without distinct damage.	Exposure at $+85 \pm 3^{\circ}$ C for 1,000 hours.
		1~2 hours exposure at room temperature and
		humidity, prior to measurement.

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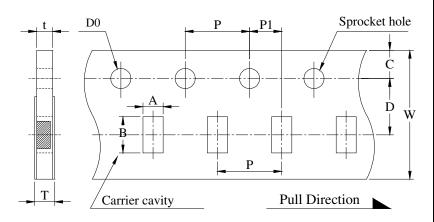
9. Packaging

9-1 Dimensions

9-1-1 Tape packaging dimensions

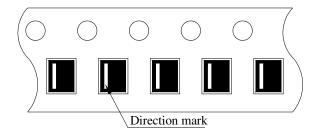
Cover Material: Polyethylene

Tape Material: Paper



Code	Dimensions (mm)
A	1.10 ±0.10
В	1.90 ±0.10
С	1.75 ±0.1
D	3.5 ±0.05
W	8.0 ±0.3
P	4.0 ±0.1
P1	2.0 ±0.05
Т	0.65 ±0.10
t	0.6 ±0.10
D0	$\phi 1.5 ^{+0.1}_{-0.0}$

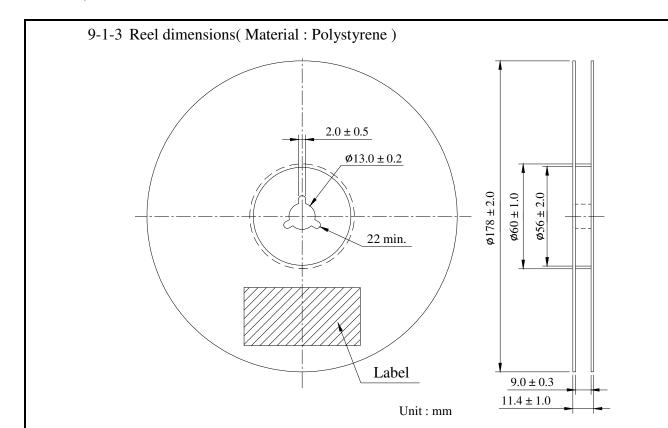
9-1-2 Setting Direction



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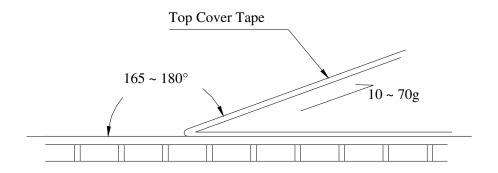
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9-2 Peel force of top cover tape

The peel speed shall be about 300 mm/minute

The peel force of top cover tape shall be between 10 to 70g



9-3 Numbers of taping

4,000 pieces/reel

9-4 Label marking

The following items shall be marked on the production and shipping Label on the reel.

9-4-1 Production Label

- (1) Part No.
- (2) Description
- (3) Quantity
- (4) Taping No.

9-4-2 Shipping Label

- (1) *Customer's name
- (2) *Customer's part No.
- (3) Manufacturer's part No.
- (4) Manufacturer's name
- (5) Manufacturer's country
- *Note: Item (1) and (2) are listed by request